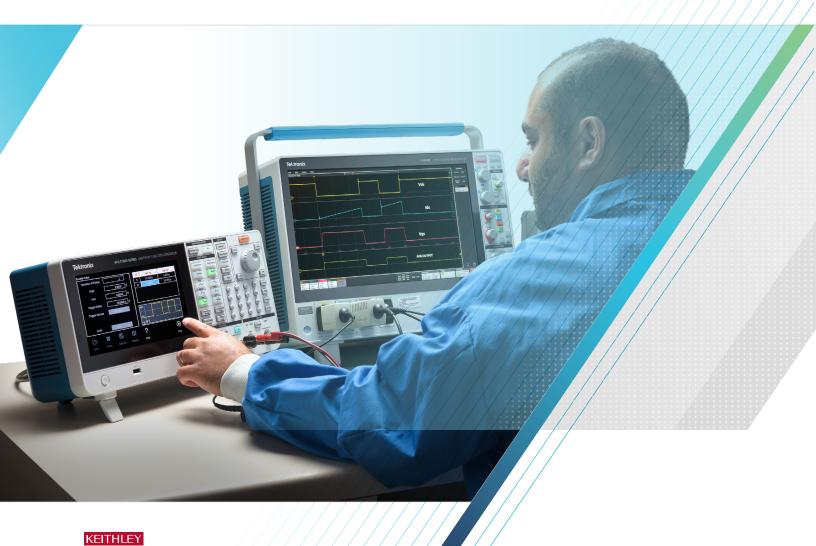
Double Pulse Testing for Power Semiconductor Devices with an Oscilloscope and Arbitrary Function Generator

APPLICATION NOTE





Introduction

Semiconductor materials used in power electronics are transitioning from silicon to wide bandgap semiconductors such as silicon carbide (SiC) and gallium nitride (GaN) due to their superior performance in automotive and industrial applications. GaN and SiC enable smaller, faster and more efficient designs. Regulatory and economic pressures continue to push efficiency gains in high-voltage power electronics designs. The power-density advantages of smaller and lighter designs are particularly evident in space-constrained and/or mobile usages such as electric vehicles, but compact power electronics are more broadly desirable as well, especially from the standpoint of reduced system cost. At the same time, efficiency is growing in importance as governments introduce financial incentives and more

stringent energy-efficiency regulations. Guidelines issued by global entities, such as the European Union's Eco-design Directive, the United States Department of Energy 2016 Efficiency Standards, and China's Quality Certification Centre (CQC) Mark govern energy efficiency requirements for electrical products and equipment. The need to enact greater energy efficiency in power electronics stretches from the point of power generation to the point of consumption, as illustrated in **Figure 1**. Power converters operate at multiple stages throughout the generation, transmission, and consumption chain, and, because none of those operations is 100% efficient, some power loss occurs at each step. Chiefly due to energy lost as heat, these reductions in overall efficiency multiply throughout the cycle. [1]

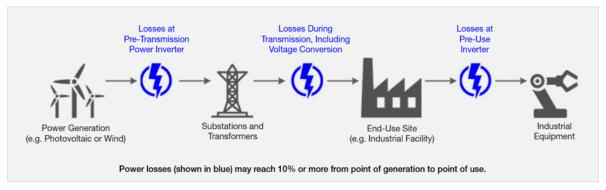


Figure 1: Power losses at the points of generation, transmission, and consumption [1].

When designing power converters, a 0% power loss is ideal as illustrated in Figure 2.

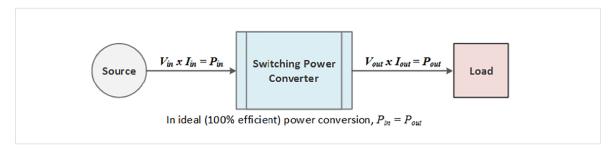


Figure 2: Ideal power conversion efficiency [1].

However, switching losses are inevitable. So, the goal is to minimize the losses through design optimization. Design parameters that are related to efficiency must be rigorously measured.

A typical converter would have an efficiency of about 87% to 90%, meaning that 10% to 13% of the input power is dissipated within the converter, mostly as waste heat. A significant portion of this loss is dissipated in the switching devices such as MOSFETs or IGBTs. [2]

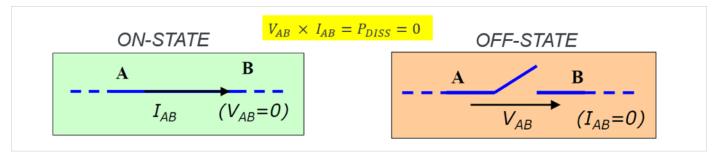


Figure 3: Ideal switching.

Ideally, the switching device is either "on" or "off" as shown in **Figure 3** and instantaneously switches between these states. In the "on" state, the impedance of the switch is zero ohms and no power is dissipated in the switch, regardless of how much current is flowing through it. In the "off" state, the impedance of the switch is infinite, and zero current is flowing, so no power is dissipated.

In practice, power is dissipated during the transition between "on" and "off" (turn-off) and between "off" and "on" (turn-on). These non-ideal behaviors occur because of parasitic elements in the circuit. As shown in **Figure 4**, the parasitic capacitances on the gate slow down the switching speed of the device, extending the turn-on and turn-off times. The parasitic resistances between the MOSFET drain and source dissipate power whenever drain current is flowing. [2]

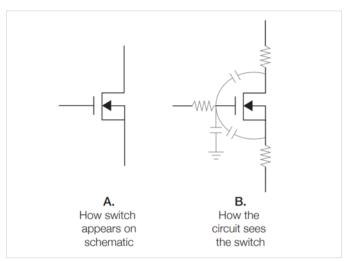


Figure 4: A: How a MOSFET appears on the schematic. B: How the circuit sees the MOSFET.

There's also reverse recovery loss of the body diode in the MOSFET to consider. Reverse recovery time of the diode is a measure of the switching speed in the diode and thus affects the switching losses in the converter design.

Therefore, design engineers will need to measure all these timing parameters in order to keep the switching losses at minimum and thus design more efficient converters.

The preferred test method to measure the switching parameters of MOSFETs or IGBTs is the "**Double Pulse Test**" method. This application note will describe the Double Pulse Test and how it's implemented. In particular, this application note will explain how to generate pulses with the Tektronix AFG31000 Arbitrary Function Generator and measure important parameters with a 4, 5 or 6 Series MSO oscilloscope.

What is the Double Pulse Test?

Double Pulse Test is a method to measure the switching parameters and evaluate the dynamic behaviors of power devices. Users of this application typically want to measure the following switching parameters: [3]

- Turn-on Parameters: Turn-on delay (t_{d(on)}), rise time (t_r),
 t_{on} (turn-on time), E_{on} (On Energy), dv/dt and di/dt. Energy loss is then determined. [4]
- Turn-off Parameters: Turn-off delay (t_{d(off)}), fall time (t_f),
 t_{off} (turn-off time), E_{off} (Off Energy), dv/dt and di/dt. Energy loss is then determined. [4]
- Reverse Recovery Parameters: t_{rr} (reverse recovery time), I_{rr} (reverse recovery current), Q_{rr} (reverse recovery charge), E_{rr} (reverse recovery energy), di/dt and V_{sd} (forward on voltage). [4]

This test is performed to:

- Guarantee specifications of power devices like MOSFETs and IGBTs.
- · Confirm actual value or deviation of the power devices or power modules.
- · Measure these switching parameters under various load conditions and validate performance across many devices.

A typical Double Pulse Test circuit is shown in Figure 5.

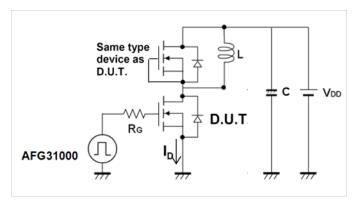


Figure 5: Double Pulse Test circuit.

The test is done with an inductive load and a power supply. The inductor is used to replicate circuit conditions in a converter design. The power supply is used to provide voltage to the inductor. The AFG31000 is used to output pulses that trigger the gate of the MOSFET and thus turns it on to start conduction of current.

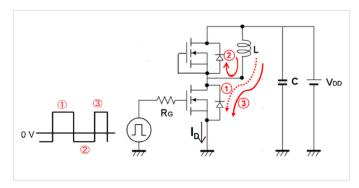


Figure 6: Current Flow with MOSFETs as DUTs.

Figure 6 shows the current flow within the different stages of the test for a Double Pulse Test with MOSFETs. The same current flow would apply when using IGBTs as shown in Figure 7.

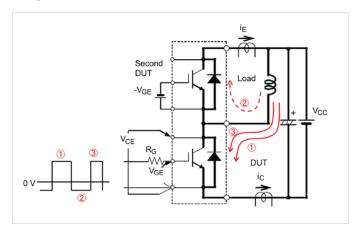


Figure 7: Current Flow using IGBTs as DUTs.

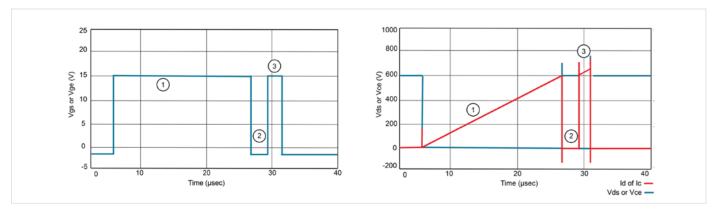


Figure 8: Typical Waveforms of the Double Pulse Test.

Figure 8 shows typical measurements taken on the low side MOSFET or IGBT. Here are the different stages of the Double Pulse Test (These stages refer to Figures 6, 7 and 8)

- The first step, represented by turn-on pulse number 1, is the initial adjusted pulse width. This establishes current in the inductor. This pulse is adjusted to get to the desired test current (I_d) as shown in Figure 8.
- The second step (2) is to turn-off the first pulse, which creates current in the free-wheeling diode. The turnoff period is short to keep the load current as close as possible to a constant value through the inductor. Figure 8 shows Id on the low side MOSFET that goes to zero in step 2; however, the current is flowing through the inductor and the high side diode. This could be seen in Figures 6 and 7, as the current flows through the diode of the high side MOSFET (the MOSFET that doesn't get turned on).
- The third step (3) is represented by the second turn-on pulse. The pulse width is shorter than the first pulse so that the device is not overheated. The second pulse needs to be long enough for the measurements to be taken. The current overshoot seen in Figure 8 is due to the reverse recovery of the free-wheeling diode from the high side MOSFET/IGBT.
- Turn-off and turn-on timing measurements are then captured at the turn-off of the first pulse and the turn-on of the second pulse.

The next section will discuss the test setup and how the measurements are taken.

Double Pulse Test Setup

Figure 9 shows the equipment setup for running a Double Pulse Test. The following equipment is required:

- AFG31000: Connects to the isolated gate driver and uses the Double Pulse Test application on the unit to quickly generate the pulses with varying pulse widths. The isolated gate driver is what turns the MOSFET on.
- Oscilloscope: 4/5/6 Series MSO (this setup uses a Tektronix 5 Series MSO): Measures V_{DS}, V_{GS}, and I_D.
- Double Pulse Test Software on the scope: Opt. WBG-DPT on the 4/5/6 Series MSO to make automated measurements
- Probes for Double Pulse Test on the low side device and diode reverse recovery on the high side:

Low side probing

- Ch1: V_{DS} TPP or THDP/TMDP Series voltage probe
- Ch2: V_{GS} TPP Series or TIVP Isolated probes with MMCX adapter tips.
- Ch3: I_D TCP Series current probe

High side probing

- Ch4: I_{RR} TCP Series current probe
- Ch5: V_{DS} THDP/TMDP Series voltage probe
- DC power supplies:

High voltage power supply:

- 2657A High Voltage Source Meter Unit (SMU) up to 3 kV
- 2260B-800-2, programmable DC power supply up to 800 V

Power supply to gate drive circuit:

- Series 2230 or Series 2280S DC power supply

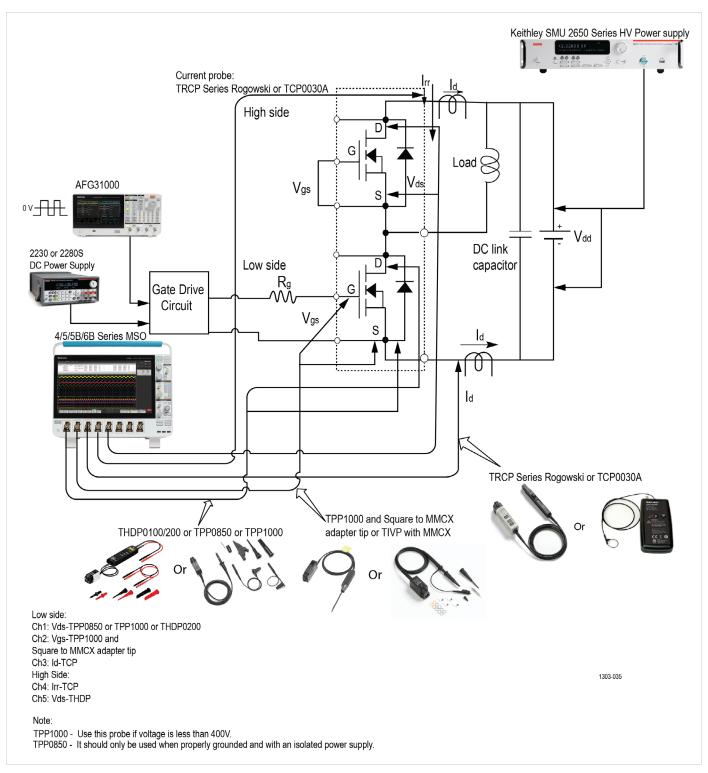


Figure 9: Double Pulse Test Setup.

Double Pulse App on the AFG31000

The AFG31000 Double Pulse Test application can be downloaded directly from the tek.com website and installed onto the AFG31000. Figure 10 shows the icon of the Double Pulse Test on the home screen of the AFG31000 after the application is downloaded and installed on the unit.

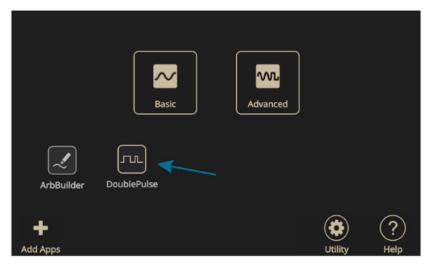


Figure 10: AFG31000 Home Screen.

The Double Pulse Test application lets the user create pulses with varying pulse widths, which has been the main user pain point due to the time-consuming methods to create pulses with varying pulse widths. Some of these methods include creating waveforms on the PC and uploading them to the function generator. Others are using microcontrollers that require a lot of effort and time to program. The Double Pulse Test application on the AFG31000 enables this from the front display. The application is intuitive and quick to setup. The first pulse width is adjusted to get the desired switching current value. The second pulse could also be adjusted independently of the first pulse and is usually shorter than the first pulse so that the power device is not destroyed. The user also has the capability of defining the time gaps between each pulse.

Figure 11 shows the Double Pulse Test application window. Here the user can set the:

- Number of pulses: 2 to 30 pulses
- High and low voltage magnitude (V)
- Trigger delay (s)
- Trigger source manual, external, or timer
- Load 50Ω or high Z

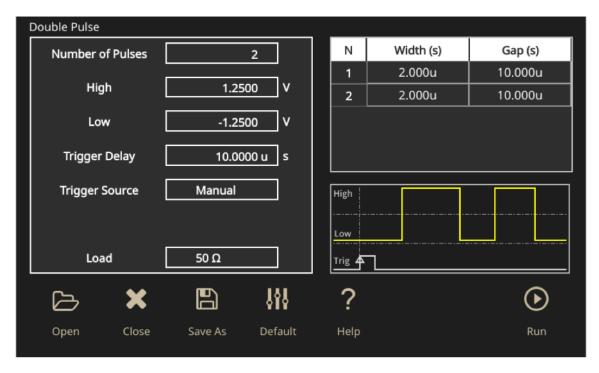


Figure 11: Double Pulse Double Pulse Test application on the AFG31000.

Figure 12 shows an actual test setup for the Double Pulse Test.

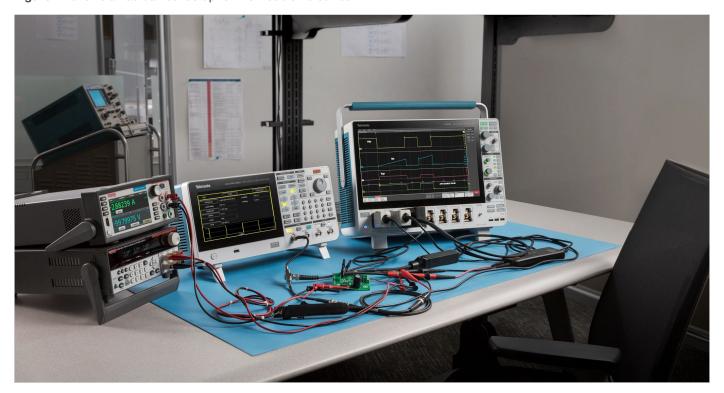


Figure 12: Double Pulse Test setup.

In this example, an ST Micro-Electronics evaluation board is being used as a gate driver for N-channel power MOSFETs and IGBTs: EVAL6498L shown in **Figure 13**.



Figure 13: EVAL6498L: https://www.st.com/en/evaluation-tools/

The MOSFETs that were used are also from ST Micro-Electronics: STFH10N60M2. These are N-channel 600V MOSFETs, rated at 7.5 A drain current.

Other equipment and devices used in the test circuit include:

- Tektronix 4, 5 or 6 Series MSO oscilloscope
- Tektronix current probe TCP0030A-120 MHz
- Tektronix high voltage differential probes: TMDP0200
- Keithley DC power supply 2280S (supplies power to the gate driver IC)
- Keithley 2461 SMU Instrument (supplies voltage to the inductor)
- Inductor: ~1 mH

The power connections are as follows:

- The MOSFETs are soldered onto the board. Q2 is the low side, and Q1 is the high side.
- Gate and source on Q1 will need to be shorted since Q1 will not be turned on.
- Gate resistor is soldered for Q2. $R = 100 \Omega$.

- CH1 from the AF31000 is connected to inputs PWM L and GND on the eval board.
- Keithley power supply is connected to V_{cc} and GND inputs on the eval board to provide power to the gate driver IC.
- Keithley 2461 SMU Instrument is connected to HV and GND to provide power to the inductor.
- The inductor is then connected to HV and OUT.

Double Pulse Test Measurements

Once all the power connections have been safely connected, we can connect the probes from the oscilloscope to Q2 (low side MOSFET) as shown in Figure 14.

- A passive probe is connected to V_{GS}.
- Differential voltage probes are connected to V_{DS}.
- TCP0030A current probe through a loop on the source lead of the MOSFET.

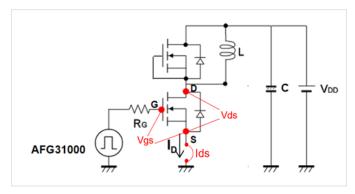


Figure 14: Scope measurements test points.

Careful probing and optimization will help the user get good results. There are steps that the user can take to make accurate and repeatable measurements like removing voltage, current and timing errors from the measurement. Automated measurement software such as the WBG-DPT option for the 4/5/6 Series MSOs eliminates manual steps to save time and provide repeatable results.

The Double Pulse Test can now be set on the AFG31000 as shown in the screen capture in Figure 15.

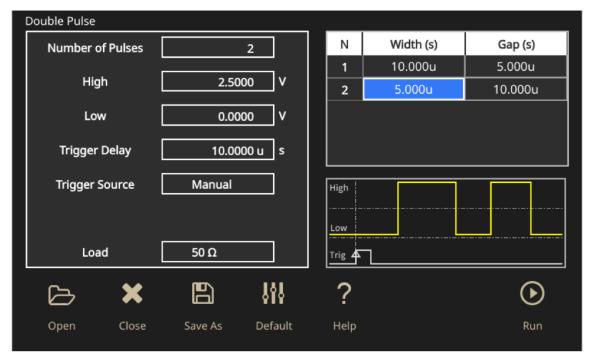


Figure 15: Double Pulse Test settings on the AFG31000.

The amplitude of the pulses is set to 2.5 V. The pulse width for the first pulse is set to 10 μ s, the gap is set to 5 μ s and the second pulse is set to 5 μ s. The trigger is set to manual.

The SMU instrument is set to source 100 V into HV. With the gate drive signal and power supplies configured, it is time to configure and perform double pulse tests using the WBG-DPT app on the oscilloscope.

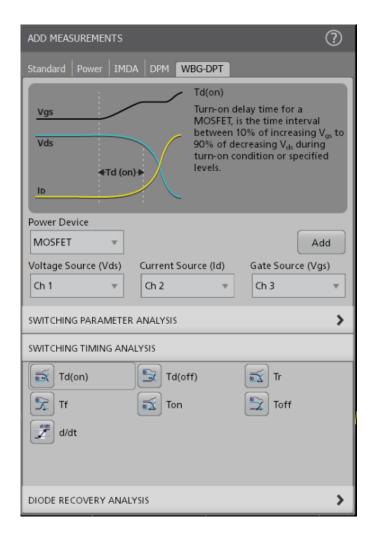
Double Pulse Test Software on the 4/5/6 Series MSO

The WBG-DPT application offers several important advantages over manual testing:

- · Shorter test times
- Enables repeatable measurements, even on signals with ringing
- Make measurements as per JEDEC/IEC standards or using custom parameters
- · Preset feature to facilitate oscilloscope setup
- Easy navigation between pulses and annotation
- Summarize measurements in results tables
- Document results with reports, session files and waveforms
- Full programmatic interface enables automation

For more information about WBG-DPT app, refer to the datasheet.

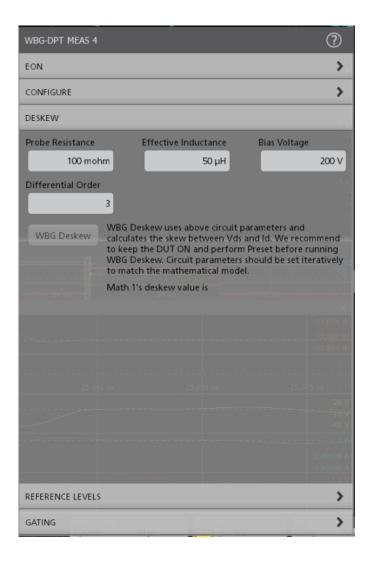
The measurements are categorized as Switching Parameter Analysis, Switching Timing Analysis and Diode Recovery Analysis.



WBG Deskew Function

The WBG deskew function calculates the skew between Drain to Source Voltage (V $_{DS}$) and Drain Current (I $_{D}$) or Collector to Emitter Voltage (V $_{CE}$) and Collector Current (I $_{C}$) when the Power Device is a MOSFET or an IGBT respectively. The skew value is then applied on to the source to which V $_{DS}$ or V $_{CE}$ signal is configured on the scope.

WBG Deskew differs from conventional scope deskew. Conventionally, skew between probes is computed before starting any measurement on test setup. In WBG, the skew of the measurement system is performed as a post-acquisition operation.



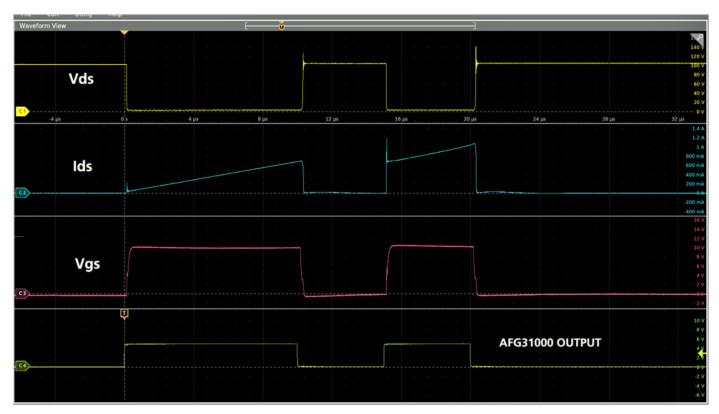


Figure 16: Double Pulse Test waveforms.

Notice the waveforms in **Figure 16** resemble the ones shown in **Figure 8**. Again, the current overshoot seen on Ids is due to reverse recovery of the free-wheeling diode from the high side MOSFET/IGBT. This spike is intrinsic to the device being used and will contribute to the losses.

Measuring Turn-on and Turn-off Timing and Energy Losses

In order to calculate the turn-on and the turn-off parameters, we look at the falling edge of the first pulse and the rising edge of the second pulse.

The industry standard to measure the turn-on and turn-off parameters is shown in **Figure 17**.

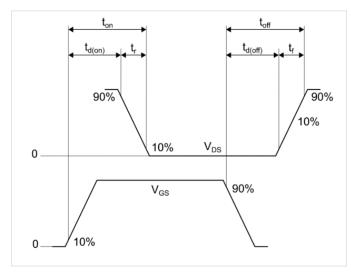


Figure 17: Switching Time Standard Waveform [5].

- t_{d(on)}: Time interval between V_{GS} at 10% of its peak and V_{ds} at 90% of its peak amplitude.
- T_r: Time interval between V_{DS} at 90% and 10% of its peak amplitude.
- t_{d(off)}: Time interval between V_{GS} at 90% of its peak and V_{ds} at 10% of its peak amplitude.
- T_f: Time interval between V_{DS} at 10% and 90% of its peak amplitude.

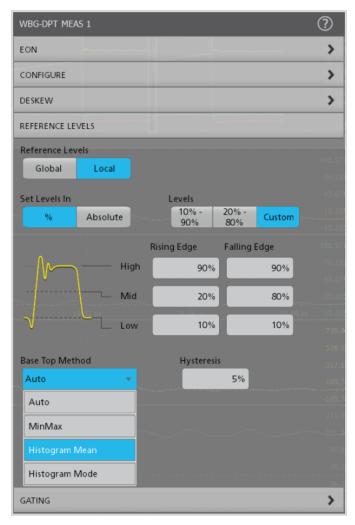


Figure 18: The DPT software on the oscilloscope supports both standard and custom reference levels. A hysteresis band sets a range on the reference level through which the signal must pass to be recognized as a transition. This helps to filter out spurious events.

Double Pulse Testing for Power Semiconductor Devices with an Oscilloscope and Arbitrary Function Generator

Figure 19 shows the waveforms captured on the scope and the measurements for turn-on parameters. On the oscilloscope, launch the WBG-DPT app. Select the 'Power Device' type as MOSFET. Configure the V_{DS} , I_{D} , and V_{GS} sources.

Go to Switching Timing Analysis group. Add $T_{d(on)}$, $T_{d(off)}$, T_{r} , and T_f measurements.

Configure T_{d(on)} measurement, click on Preset. This arms the scope for a single acquisition.

Turn on the Power supplies.

Turn on the AFG31000 to generate the output pulses.

The resulting waveforms are captured on the scope as shown in Figure 19.

The following equation is then used to calculate the energy losses during the transition:

$$E_{on} = \int_0^t V_{DS} I_{DS} dt \tag{1}$$

Typically, designers would use the integral function on the oscilloscope for this specific energy loss computation. The WBG-DPT app offers the **Eon** measurement under the Switching Parameter Analysis group. This measurement sets up the integration and quickly displays the result.

The same equation from above can be used to calculate energy losses during the turn-off transition:

$$E_{off} = \int_0^t V_{DS} I_{DS} dt \tag{2}$$

The DPT application includes an automatic Eoff measurement in the Switching Parameter Analysis menu. This performs the calculations and provides the energy loss results directly.

Note: The data shown in scope captures is for reference only.



Figure 19: Turn-on parameters waveforms.

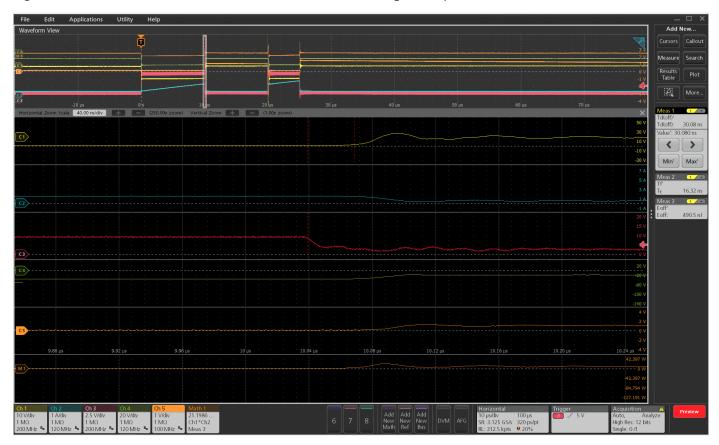


Figure 20 shows the turn-off waveforms measurements obtained using the scope cursors.

Figure 20: Turn-off parameters waveforms.

Measuring Reverse Recovery

Now, the reverse recovery characteristics of the MOSFET need to be measured.

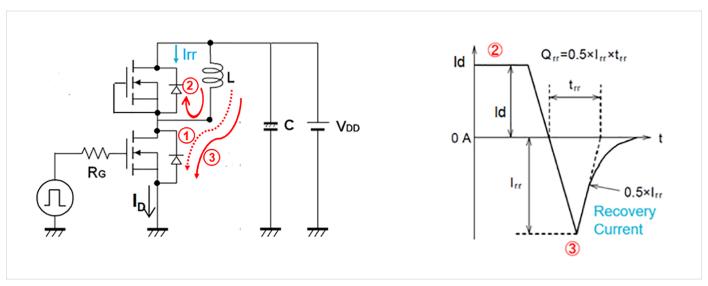


Figure 21: Diode reverse recovery.

Double Pulse Testing for Power Semiconductor Devices with an Oscilloscope and Arbitrary Function Generator

Reverse recovery current occurs during the turn-on of the second pulse. As shown in **Figure 21**, the diode is conducting in a forward condition during phase 2. As the low side MOSFET turns on again, the diode should immediately switch to a reverse blocking condition; however, the diode will conduct in a reverse condition for a short period of time, which is known as the reverse recovery current. This reverse recovery current is translated into energy losses, which directly impact the efficiency of the power converter.

The measurements are now done on the high side MOSFET. $\rm I_{\rm d}$ is measured through the high side MOSFET and $\rm V_{\rm sd}$ across the diode.

Figure 21 also shows how reverse recovery parameters are retrieved below.

Reverse Recovery Parameters: t_{rr} (reverse recovery time), I_{rr} (reverse recovery current), Q_{rr} (reverse recovery charge), E_{rr} (reverse recovery energy), di/dt, and V_{sd} (forward on voltage).

The following equation is then used to calculate the energy losses during the transition:

$$E_{rr} = \int_0^t V_{sd} I_{rr,max} dt \tag{3}$$

The WBG-DPT supports T_{rr} , Q_{rr} , and E_{rr} measurements under the Diode Reverse Recovery group. The waveforms and captured results are shown in **Figure 22**.

Multiple T_{rr} measurements can also be displayed in an overlapped plot that shows selected pulse with annotation, tangent lines and configured values.

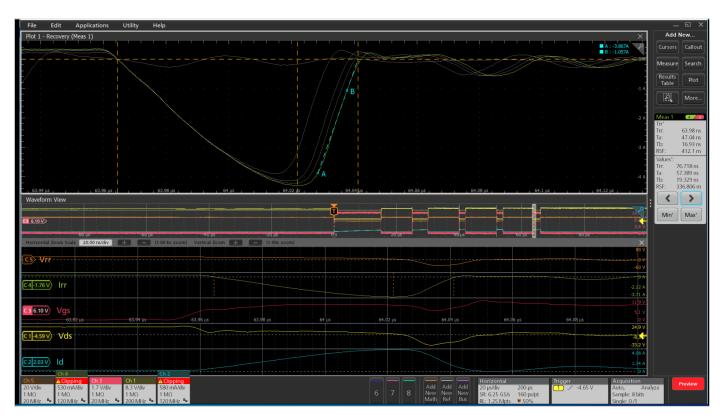


Figure 22: Reverse recovery waveforms. The waveforms in the top part of the display show an overlapped plot of multiple events. The tangent line (A-B) indicates the event currently selected for measurement.

Conclusion

Double Pulse Test is the preferred test method to measure the switching parameters and evaluate the dynamic behaviors of power devices. Test and design engineers that use this application are interested in understanding the switching, timing, and reverse recovery behaviors of the power devices. The test requires two voltage pulses with varying pulse widths, which is the main user pain point due to the timeconsuming methods to create pulses with varying pulse widths. Some of these methods include creating waveforms on the PC and uploading them to the function generator. Others are using microcontrollers that require a lot of effort and time to program. This application note has shown that the Tektronix AFG31000 Arbitrary Function Generator offers a straight forward method to create pulses with varying pulse widths right on the front display. The Double Pulse Test

application on the AFG31000 is guick to set up and to output pulses, thus allowing design and test engineers to focus on gathering data and designing more efficient converters.

The WBG-DPT double pulse application on the 4/5/6 Series MSO enables standard-specific tests to analyze power devices' behavior while saving time compared to manual testing.

The application includes a preset feature to help capture the right waveform, detailed configuration options to test beyond the standards, enables signal conditioning feature for analyzing noisy waveforms, offers navigation and annotation feature, and offers detailed documentation to enable repeatable measurements.

Automated double pulse test setup and analysis on the AFG31000 and 4/5/6/ Series MSO combine to greatly reduce test times and achieve faster time to market for next generation power converters.

References

- https://www.tek.com/document/technical-brief/evolving-materials-and-testing-emerging-generations-power-electronics
- https://www.tek.com/document/application-note/measuring-power-supply-switching-loss-oscilloscope
- Infineon: Double Pulse Test for IGBT & FWD Principle https://u.dianyuan.com/upload/space/2011/07/29/1311925659-501009.pdf
- 4. https://training.ti.com/understanding-mosfet-datasheets-switching-parameters
- https://www.mouser.com/datasheet/2/389/stfh10n60m2-974335.pdf 5.
- https://www.st.com/resource/en/data_brief/eval6498l.pdf
- 7. https://www.tek.com/datasheet/advanced-power-measurement-and-analysis
- https://www.tek.com/document/application-note/measuring-vgs-wide-bandgap-semiconductors

Contact Information:

Australia 1 800 709 465

Austria* 00800 2255 4835

Balkans, Israel, South Africa and other ISE Countries +41 52 675 3777

Belgium* 00800 2255 4835

Brazil +55 (11) 3530-8901

Canada 1 800 833 9200

Central East Europe / Baltics +41 52 675 3777

Central Europe / Greece +41 52 675 3777

Denmark +45 80 88 1401

Finland +41 52 675 3777

France* 00800 2255 4835

Germany* 00800 2255 4835 Hong Kong 400 820 5835

India 000 800 650 1835

Indonesia 007 803 601 5249

Italy 00800 2255 4835

Japan 81 (3) 6714 3086

Luxembourg +41 52 675 3777

Malaysia 1 800 22 55835

Mexico, Central/South America and Caribbean 52 (55) 88 69 35 25

Middle East, Asia, and North Africa +41 52 675 3777

The Netherlands* 00800 2255 4835

New Zealand 0800 800 238

Norway 800 16098

People's Republic of China 400 820 5835

Philippines 1 800 1601 0077

Poland +41 52 675 3777

Portugal 80 08 12370

Republic of Korea +82 2 565 1455

Russia / CIS +7 (495) 6647564

Singapore 800 6011 473

South Africa +41 52 675 3777

Spain* 00800 2255 4835

Sweden* 00800 2255 4835

Switzerland* 00800 2255 4835 Taiwan 886 (2) 2656 6688

Thailand 1 800 011 931

United Kingdom / Ireland* 00800 2255 4835

USA 1 800 833 9200

Vietnam 12060128

* European toll-free number. If not

accessible, call: +41 52 675 3777

Rev. 02.2022





